

LMV422 Dual Rail-to-Rail Output Operational Amplifier with Power Select

Check for Samples: [LMV422](#)

FEATURES

- Supply voltage 2.7V to 5.5V
- Supply current per channel
 - Low power mode 2 μ A
 - Full power mode 400 μ A
- Input common mode voltage range $-0.3V$ to $3.8V$
- CMRR 85 dB
- Output voltage swing Rail-to-Rail
- Input offset voltage 1 mV
- Bandwidth

- Low power mode 27 kHz
- Full power mode 8 MHz
- Stable for $A_V \geq +2$ or $A_V \leq -1$

APPLICATIONS

- AC coupled circuits
- Portable instrumentation
- Smoke detectors

DESCRIPTION

The LMV422 dual rail-to-rail output amplifier offers a power select pin (PS) that allows the user to select one of two power modes depending on the level of performance desired. This is ideal for AC coupled circuits where the circuit needs to be kept active to maintain a quiescent charge on the coupling capacitors with minimum power consumption.

For portable applications, the LMV422 operates in low power mode consuming only 2 μ A of supply current per channel at a bandwidth of 27 kHz. This allows the user to reduce the power consumption of an amplifier while maintaining an active circuit. For additional bandwidth and output current drive the amplifier can be switched to full power mode with 8 MHz bandwidth while consuming only 400 μ A per channel.

The LMV422 features a rail-to-rail output voltage swing in addition to an input common mode range that includes ground. The LMV422 is designed for closed loop gains of plus two (or minus one) or greater. The LMV422 is offered in a 10-Pin MSOP miniature package to ease the adoption in applications where board area is at a premium.

Typical Application

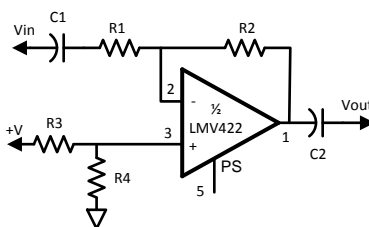


Figure 1. AC Coupled Application



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



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Absolute Maximum Ratings

(1)

ESD Tolerance ⁽²⁾	
Human Body	2000V
Machine Model	200V
V _{IN} Differential	±2V
Supply Voltage (V ⁺ - V ⁻)	2.5V to 5.5V
Storage Temperature Range	-65°C to +150°C
Junction Temperature ⁽³⁾	+150°C
Soldering Information	
Infrared or Convection (20 sec)	235°C
Wave Soldering Lead Temp. (10 sec)	260°C

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.
- (2) Human Body Model, 1.5 kΩ in series with 100 pF, Machine Model, 0Ω in series with 200 pF.
- (3) The maximum power dissipation is a function of T_{J(MAX)}, θ_{JA}, and T_A. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / \theta_{JA}$. All numbers apply for packages soldered directly onto a PC board.

Operating Ratings⁽¹⁾

Supply Voltage (V ⁺ - V ⁻)	2.7V to 5.5V
Temperature Range ⁽²⁾	-40°C to +85°C
Package Thermal Resistance (θ _{JA})	
10-Pin MSOP	210°C/W

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.
- (2) Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C.

5V Full Power Mode Electrical Characteristics

Unless otherwise specified, all limits guaranteed for $T_J = 25^\circ\text{C}$, $V^+ = 5\text{V}$, $V^- = 0\text{V}$, $V_{CM} = V_O = V^+/2$, $PS = V^-$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (1)	Typ (2)	Max (1)	Units
V_{OS}	Input Offset Voltage			1	4 5.5	mV
ΔV_{OS}	Input Offset Voltage Difference	V_{OS} in Full Power Mode – V_{OS} in Low Power Mode		0.1	1	mV
$TC\ V_{OS}$	Input Offset Average Drift	(3)		2		$\mu\text{V}/^\circ\text{C}$
I_B	Input Bias Current			5		pA
CMRR	Common Mode Rejection Ratio	V_{CM} Stepped from 0V to 3.5V	68 60	85		dB
PSRR	Power Supply Rejection Ratio	$V^+ = 2.7\text{V}$ to 5V	66 60	90		dB
CMVR	Input Common Mode Voltage Range	CMRR ≥ 50 dB	-0.3		3.8	V
A_{VOL}	Large Signal Voltage Gain	$V_O = 0.75\text{V}$ to 4.25V $R_L = 1\text{ M}\Omega$	72 70	100		dB
		$V_O = 0.75\text{V}$ to 4.25V $R_L = 10\text{ k}\Omega$	75 70	102		
V_O	Output Swing High	$R_L = 10\text{ k}\Omega$ to $V^+/2$	4.93 4.88	4.97		V
		$R_L = 1\text{ M}\Omega$ to $V^+/2$	4.94 4.89	4.98		
	Output Swing Low	$R_L = 10\text{ k}\Omega$ to $V^+/2$		33	180 230	mV
		$R_L = 1\text{ M}\Omega$ to $V^+/2$		25	120 170	
I_{SC}	Output Short Circuit Current	Sourcing, $V_O = 0\text{V}$ $V_{ID} = 100\text{ mV}$	3	5		mA
		Sinking, $V_O = 5\text{V}$ $V_{ID} = -100\text{ mV}$	9	16		
I_S	Supply Current Per Channel	$PS \leq 0.5\text{V}$		400	650 900	μA
SR	Slew Rate (4)	$V_O = 3\text{V}$, $A_V = +2$	1.8	3.8		$\text{V}/\mu\text{s}$
GBW	Gain Bandwidth Product			8		MHz
e_n	Input-Referred Voltage Noise	$f = 100\text{ kHz}$		20		$\text{nV}/\sqrt{\text{Hz}}$
		$f = 1\text{ kHz}$		25		
i_n	Input-Referred Current Noise	$f = 1\text{ kHz}$		0.006		$\text{pA}/\sqrt{\text{Hz}}$
t_{LF}	Time from Low Power Mode to Full Power Mode			210		ns
TH_{PS}	Full Power Mode Voltage Threshold				0.5	V
I_{PS}	Input Current PS pin (5)			-2		μA

(1) All limits are guaranteed by testing or statistical analysis.

(2) Typical values represent the most likely parametric norm.

(3) Offset voltage average drift is determined by dividing the change in V_{OS} at temperature extremes into the total temperature change.

(4) Slew rate is the average of the rising and falling slew rates.

(5) Positive current corresponds to current flowing into the device.

5V Low Power Mode Electrical Characteristics

Unless otherwise specified, all limits guaranteed for $T_J = 25^\circ\text{C}$, $V^+ = 5\text{V}$, $V^- = 0\text{V}$, $V_{CM} = V_O = V^+/2$, $PS = V^+$ or Open.

Boldface limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (1)	Typ (2)	Max (1)	Units
V_{OS}	Input Offset Voltage			1	4 5.5	mV
ΔV_{OS}	Input Offset Voltage Difference	V_{OS} in Full Power Mode – V_{OS} in Low Power Mode		0.1	1	mV
$TC\ V_{OS}$	Input Offset Average Drift	(3)		2		$\mu\text{V}/^\circ\text{C}$
I_B	Input Bias Current			5		pA
CMRR	Common Mode Rejection Ratio	V_{CM} Stepped from 0V to 3.5V	60 55	82		dB
PSRR	Power Supply Rejection Ratio	$V^+ = 2.7\text{V}$ to 5V	62 60	90		dB
CMVR	Input Common-Mode Voltage Range	CMRR ≥ 50 dB	0		3.5	V
A_{VOL}	Large Signal Voltage Gain	$R_L = 1\text{ M}\Omega$ $V_O = 0.75$ to 4V	62 54	72		dB
V_O	Output Swing High	$R_L = 1\text{ M}\Omega$	4.94 4.89	4.98		V
	Output Swing Low	$R_L = 1\text{ M}\Omega$		150	200 250	mV
I_{SC}	Output Short Circuit Current	Sourcing, $V_O = 0\text{V}$ $V_{ID} = 200\text{ mV}$	40	140		μA
		Sinking, $V_O = 5\text{V}$ $V_{ID} = -200\text{ mV}$	25	130		
I_S	Supply Current per channel	$PS \geq 4.5\text{V}$		2	3.5 4.5	μA
SR	Slew Rate (4)	$V_O = 3\text{V}$, $A_V = +2$	8	14		V/ms
GBW	Gain Bandwidth Product			27		kHz
e_n	Input-Referred Voltage Noise	$f = 100\text{ kHz}$		40		$\text{nV}/\sqrt{\text{Hz}}$
		$f = 1\text{ kHz}$		60		
i_n	Input-Referred Current Noise	$f = 1\text{ kHz}$		0.06		$\text{pA}/\sqrt{\text{Hz}}$
t_{FL}	Time from Full Power Mode to Low Power Mode			500		ns
TH_{PS}	Low Power Mode Voltage Threshold		4.5			V
I_{PS}	Input Current PS pin (5)			8		nA

(1) All limits are guaranteed by testing or statistical analysis.

(2) Typical values represent the most likely parametric norm.

(3) Offset voltage average drift is determined by dividing the change in V_{OS} at temperature extremes into the total temperature change.

(4) Slew rate is the average of the rising and falling slew rates.

(5) Positive current corresponds to current flowing into the device.

Connection Diagram

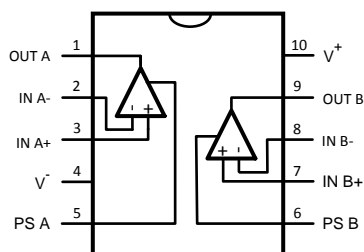
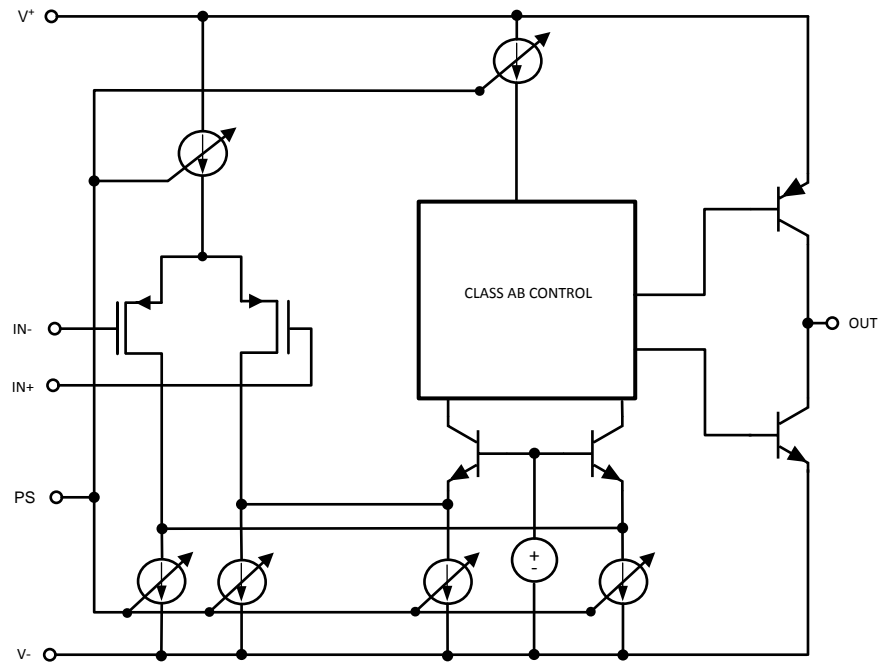


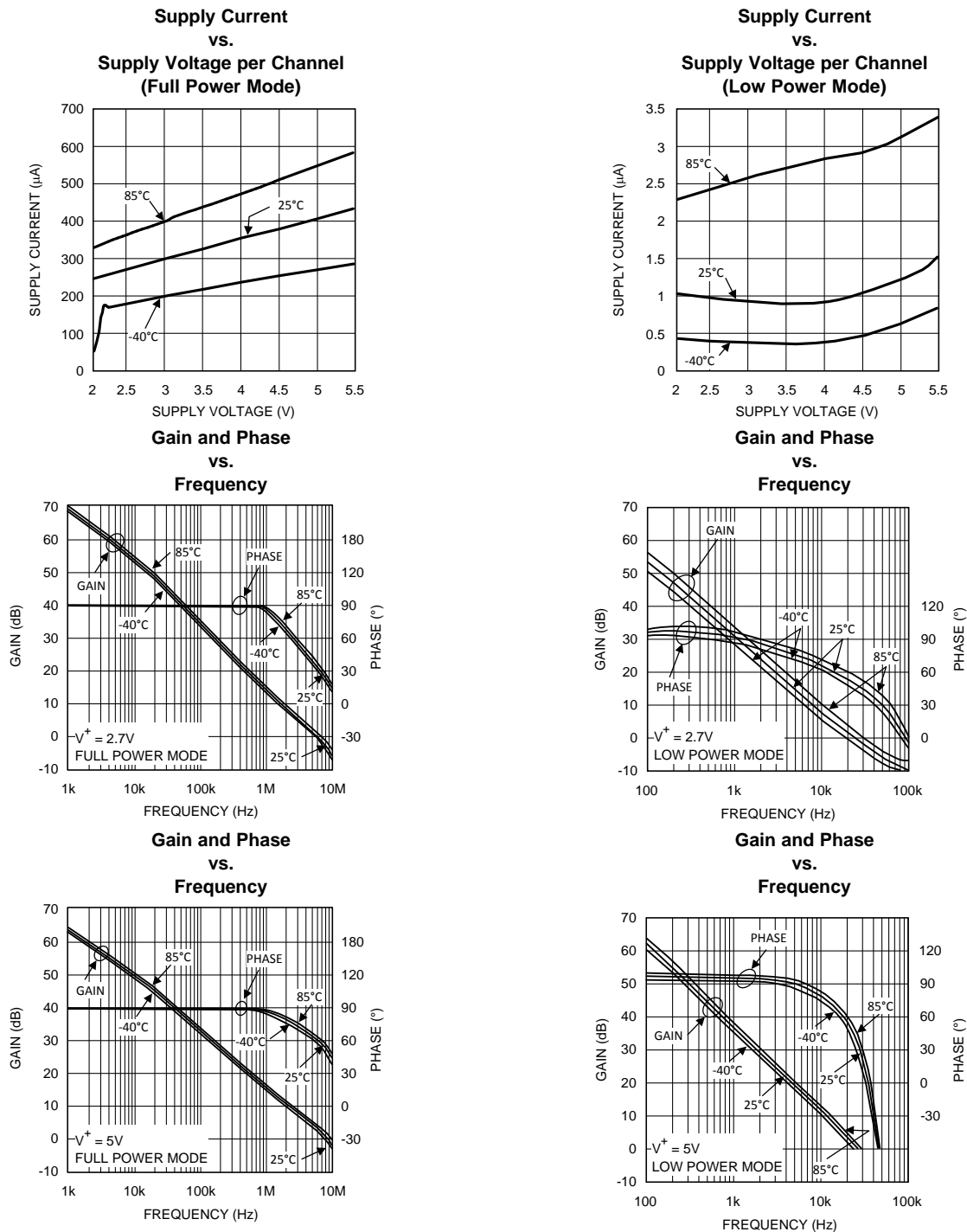
Figure 2. 10-Pin MSOP (Top View)

Simplified Schematic



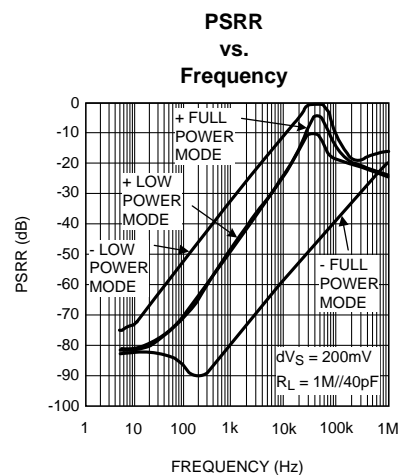
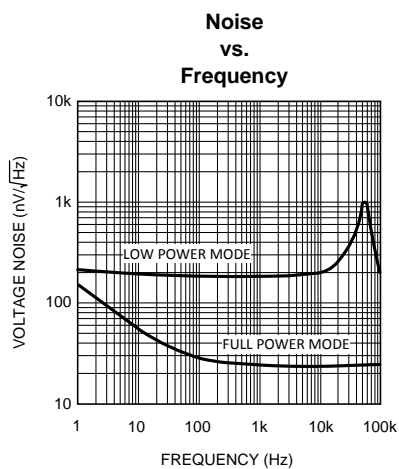
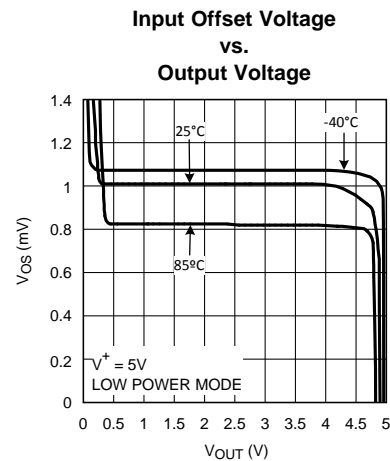
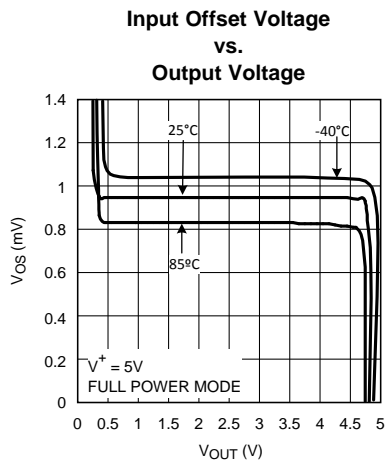
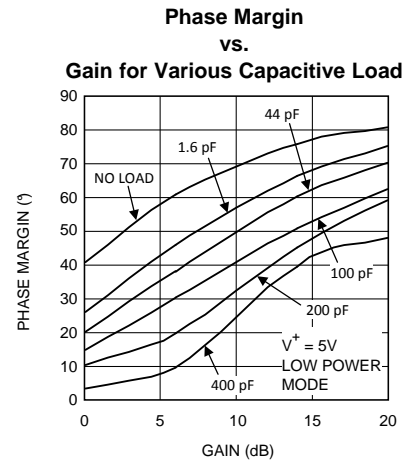
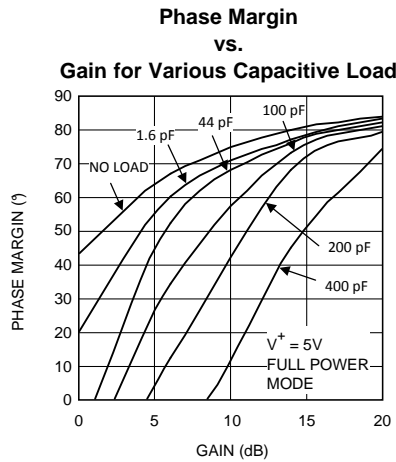
Typical Performance Characteristics

Unless otherwise specified, $V^+ = 5V$, $T_A = 25^\circ C$, $PS = V^+$ for Full Power Mode, $PS = V^-$ for Low Power Mode.



Typical Performance Characteristics (continued)

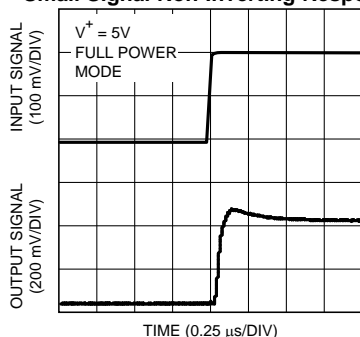
Unless otherwise specified, $V^+ = 5V$, $T_A = 25^\circ C$, $PS = V^+$ for Full Power Mode, $PS = V^-$ for Low Power Mode.



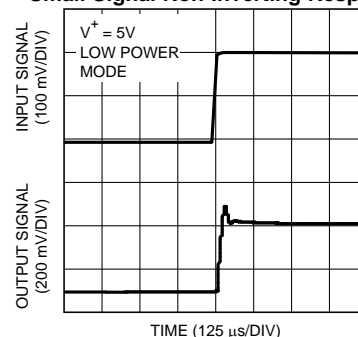
Typical Performance Characteristics (continued)

Unless otherwise specified, $V^+ = 5V$, $T_A = 25^\circ C$, $PS = V^+$ for Full Power Mode, $PS = V^-$ for Low Power Mode.

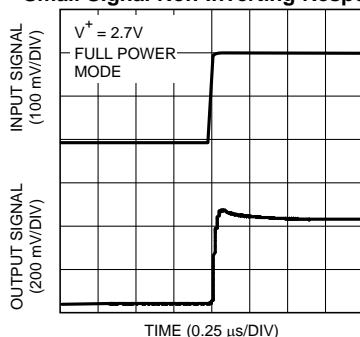
Small Signal Non-Inverting Response



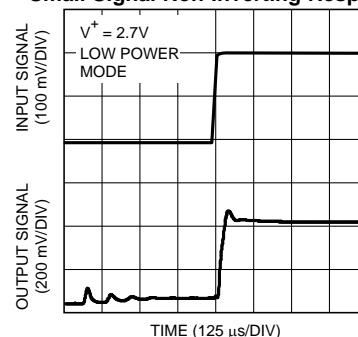
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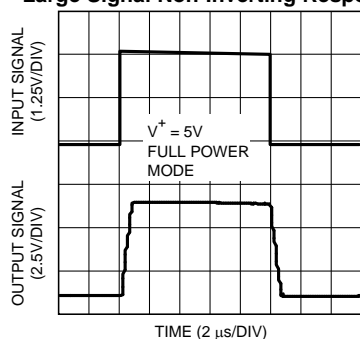
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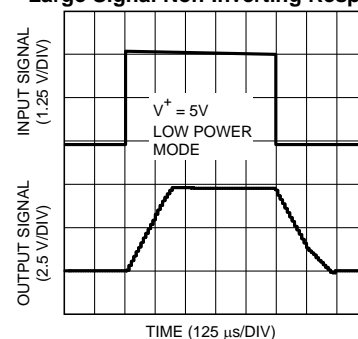
Small Signal Non-Inverting Response



Large Signal Non-Inverting Response



Large Signal Non-Inverting Response



Application Information

The LMV422 is a dual rail-to-rail output amplifier that can be switched between two active power modes. The power select pin (PS) provides a method to optimize the power consumption, bandwidth and short circuit current. When the PS pin is set to greater than 4.5V (Figure 3) or left open, the LMV422 is in Low Power Mode operating at a bandwidth of 27 kHz and is consuming only 2 μA of supply current per channel. Setting the PS pin to less than 0.5V, switches the LMV422 to Full Power Mode with a bandwidth of 8 MHz and supply current of 400 μA per channel (Figure 4). The PS pin should not exceed the supply voltage. The active power modes of the two amplifiers can be set independently.

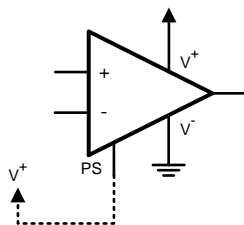


Figure 3. Low Power Mode

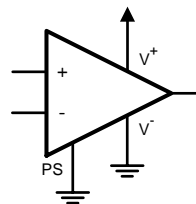


Figure 4. Full Power Mode

The LMV422 PS pin has an internal pull up and a logic level control gate that makes it easy for the PS pin to be controlled by the output of a logic gate or the output pin of a microcontroller. The following figures show the three typical output configurations for logic gates and microcontrollers.

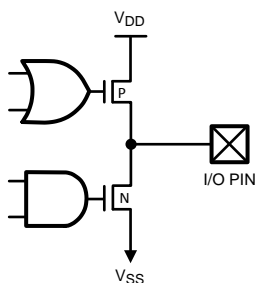


Figure 5. (a) Typical Output Configurations for Logic Gates and Microcontrollers

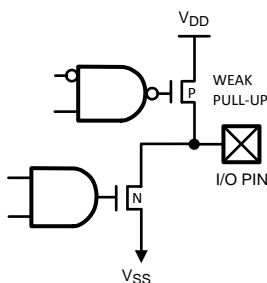


Figure 6. (b) Typical Output Configurations for Logic Gates and Microcontrollers

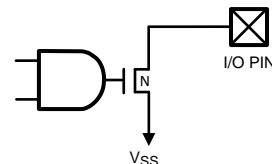


Figure 7. (c) Typical Output Configurations for Logic Gates and Microcontrollers

CAPACITIVE LOAD TOLERANCE

The LMV422 is optimized for maximum bandwidth when operating at a minimum closed loop gain of +2 or -1; therefore, it is not recommended that it be configured as a buffer. Like many other op amps, the LMV422 may oscillate when the applied load appears capacitive. The threshold of the oscillation varies both with load and circuit gain. (See Phase Margin vs. Gain for Various Capacitive Loads.) The load capacitance interacts with the amplifier's output resistance to create an additional pole. If this pole frequency is too low, it will degrade the amplifier's phase margin so that the amplifier is no longer stable.

Figure 8 and Figure 9 show the addition of a small value resistor R_{ISO} or R_X (50Ω to 100Ω) in series with the op amp's output. Figure 9 shows the addition of a capacitor C_F (5 pF to 10 pF) between the inverting input and the output pin. This additional capacitor returns the phase margin to a safe value without interfering with lower frequency circuit operation. Note that in all cases, the output will ring heavily when the load capacitance is near the threshold for oscillation.

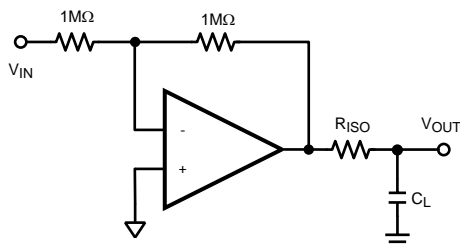


Figure 8. Capacitive Load Tolerance

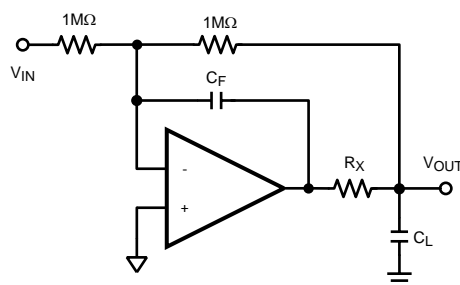


Figure 9. Capacitive Load Tolerance

AC COUPLED CIRCUITS

The two power modes makes the LMV422 ideal for AC coupled circuits where the circuit needs to be kept active to maintain a quiescent charge on the coupling capacitors with minimum power consumption.

Figure 10 shows a schematic of an inverting and non-inverting AC coupled amplifiers using the LMV422 with the PS pins controlled by I/O ports of a microcontroller.

The advantage of the low power active mode for AC coupled amplifiers is the elimination of the time needed to re-establish a quiescent operating point when the amplifier is switched to a full power mode. When amplifiers without a low power active mode are used in low power applications, there are two ways to minimize power consumption. The first is turning off the amplifiers by switching off power to the op amps using a transistor switch. The second is using an amplifier with a shut down pin. Both of these methods have the problem of allowing the coupling capacitors, C1, C2, C3, C4, and C5, to discharge the quiescent DC voltage stored on them when the amplifiers are placed in the shut down state. When the amplifiers are turned on again, the quiescent DC voltages must reestablish themselves. During this time, the amplifier's output is not usable because the output signal is a mixture of the amplified input signal and the charging voltage on the coupling capacitors. The settling time can range from several milliseconds to several seconds depending on the resistor and capacitor values.

When the LMV422 is placed into the low power mode the power consumption is minimal but the amplifier is active to maintain the quiescent DC voltage on the coupling capacitors. The transition back to the operational high power mode is fast, within a few hundred nanoseconds. The active low power mode of the LMV422 satisfies the two critical aspects of a low power AC amplifier design. The values of the gain resistors, bias resistors, and coupling capacitors can be chosen independently of the turn on and stabilization time.

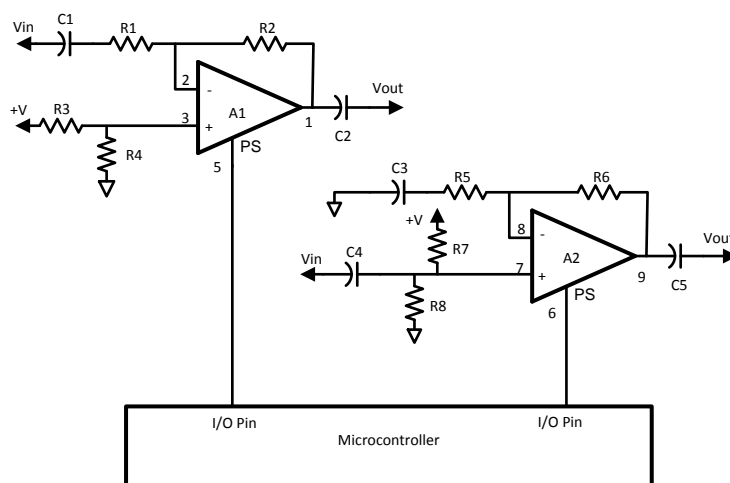


Figure 10. Inverting and Non-Inverting AC Coupled Amplifiers Using the LMV422

RESISTIVE LOAD

The LMV422 has a minimum current drive of 3 mA in full power mode. The minimum resistive load should be 10 k Ω

The current drive in the low power mode is 140 μ A, the minimum resistive load should be 100 k Ω .

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